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June 2015

FDS4465_F085

P-Channel 1.8V Specified PowerTrench® MOSFET

General Description

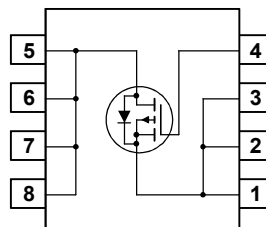
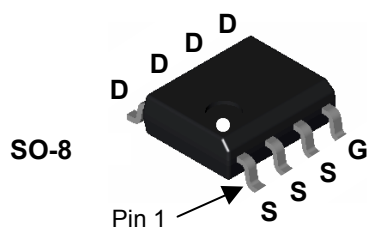
This P-Channel 1.8V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (1.8V – 8V).

Applications

- Power management
- Load switch
- Battery protection

Features

- –13.5 A, –20 V. $R_{DS(ON)} = 8.5 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
 $R_{DS(ON)} = 10.5 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$
 $R_{DS(ON)} = 14 \text{ m}\Omega @ V_{GS} = -1.8 \text{ V}$
- Fast switching speed
- High performance trench technology for extremely low $R_{DS(ON)}$
- High current and power handling capability
- Qualified to AEC Q101
- RoHS Compliant



Absolute Maximum Ratings

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain-Source Voltage	–20	V
V_{GSS}	Gate-Source Voltage	± 8	V
I_D	Drain Current – Continuous (Note 1a) – Pulsed	–13.5	A
		–50	
P_D	Power Dissipation for Single Operation (Note 1a) (Note 1b) (Note 1c)	2.5	W
		1.2	
		1	
T_J, T_{STG}	Operating and Storage Junction Temperature Range	–55 to +150	$^\circ\text{C}$

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	85	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1c)	125	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)	25	$^\circ\text{C/W}$

Package Marking and Ordering Information

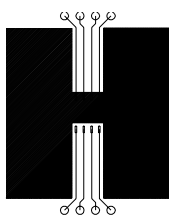
Device Marking	Device	Reel Size	Tape width	Quantity
FDS4465	FDS4465_F085	13"	12mm	2500 units

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

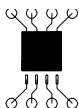
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV _{DSS}	Drain–Source Breakdown Voltage	V _{GS} = 0 V, I _D = −250 μA	−20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = −250 μA, Referenced to 25°C		−12		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = −16 V, V _{GS} = 0 V			−1	μA
I _{GSSF}	Gate–Body Leakage, Forward	V _{GS} = 8 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	V _{GS} = −8 V, V _{DS} = 0 V			−100	nA
On Characteristics (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = −250 μA	−0.4	−0.6	−1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I _D = −250 μA, Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	V _{GS} = −4.5 V, I _D = −13.5 A V _{GS} = −2.5 V, I _D = −12 A V _{GS} = −1.8 V, I _D = −10.5 A V _{GS} = −4.5 V, I _D = −13.5 A, T _J = 125°C		6.7 8.0 9.8 9.0	8.5 10.5 14 13	mΩ
I _{D(on)}	On–State Drain Current	V _{GS} = −4.5 V, V _{DS} = −5 V	−50			A
g _{FS}	Forward Transconductance	V _{DS} = −5 V, I _D = −13.5 A		70		S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} = −10 V, V _{GS} = 0 V, f = 1.0 MHz		8237		pF
C _{oss}	Output Capacitance			1497		pF
C _{rss}	Reverse Transfer Capacitance			750		pF
Switching Characteristics (Note 2)						
t _{d(on)}	Turn–On Delay Time	V _{DD} = −10V, I _D = −1 A, V _{GS} = −4.5 V, R _{GEN} = 6 Ω		20	36	ns
t _r	Turn–On Rise Time			24	38	ns
t _{d(off)}	Turn–Off Delay Time			300	480	ns
t _f	Turn–Off Fall Time			140	224	ns
Q _g	Total Gate Charge	V _{DS} = −10 V, I _D = −13.5 A, V _{GS} = −4.5 V		86	120	nC
Q _{gs}	Gate–Source Charge			20		nC
Q _{gd}	Gate–Drain Charge			11		nC
Drain–Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain–Source Diode Forward Current				−2.1	A
V _{SD}	Drain–Source Diode Forward Voltage	V _{GS} = 0 V, I _S = −2.1 A (Note 2)		−0.6	−1.2	V

Notes

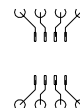
1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 50 $^\circ\text{C/W}$ when mounted on a 1in² pad of 2 oz copper



b) 105 $^\circ\text{C/W}$ when mounted on a .04 in² pad of 2 oz copper



c) 125 $^\circ\text{C/W}$ when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μs , Duty Cycle < 2.0%

Typical Characteristics

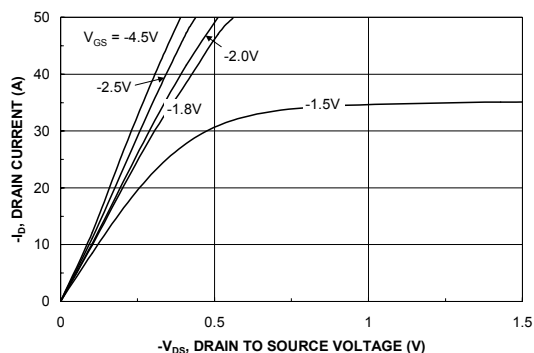


Figure 1. On-Region Characteristics.

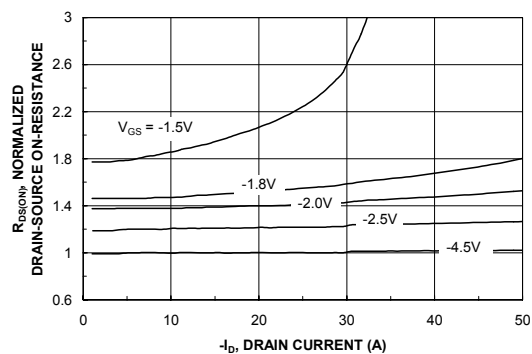


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

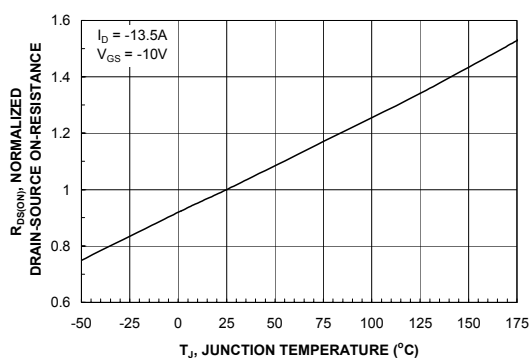


Figure 3. On-Resistance Variation with Temperature.

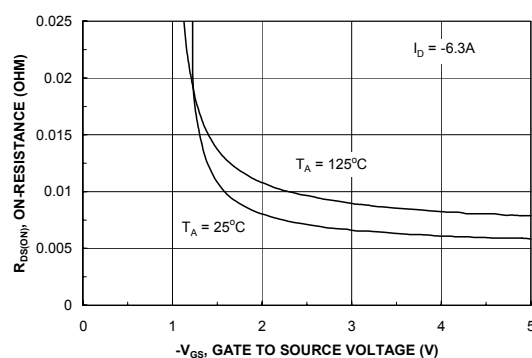


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

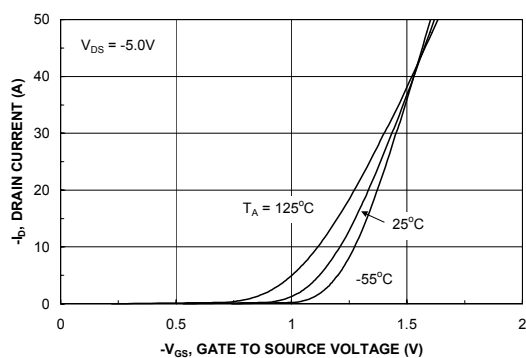


Figure 5. Transfer Characteristics.

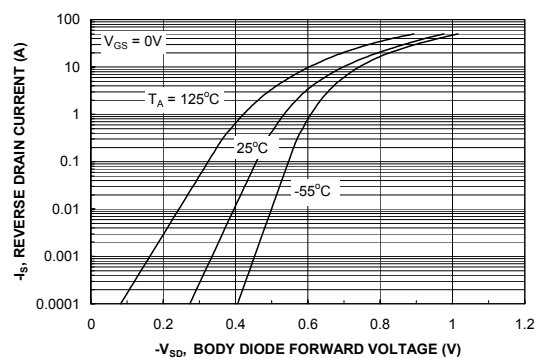


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics

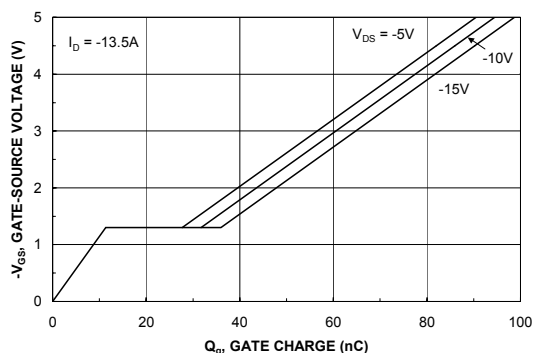


Figure 7. Gate Charge Characteristics.

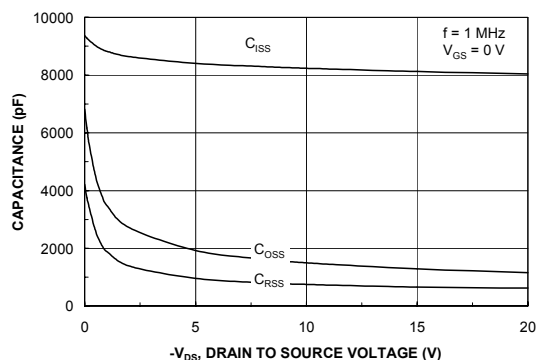


Figure 8. Capacitance Characteristics.

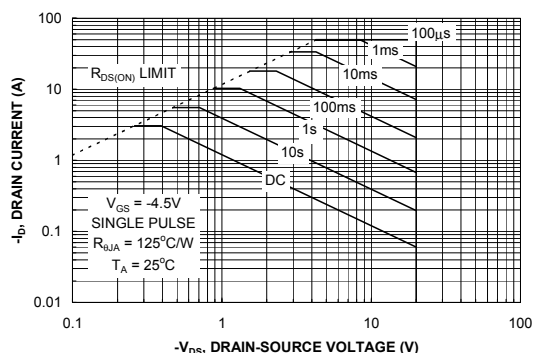


Figure 9. Maximum Safe Operating Area.

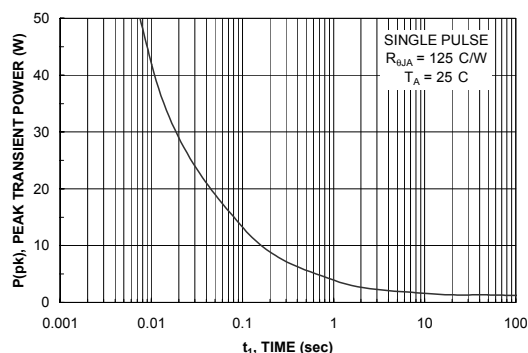


Figure 10. Single Pulse Maximum Power Dissipation.

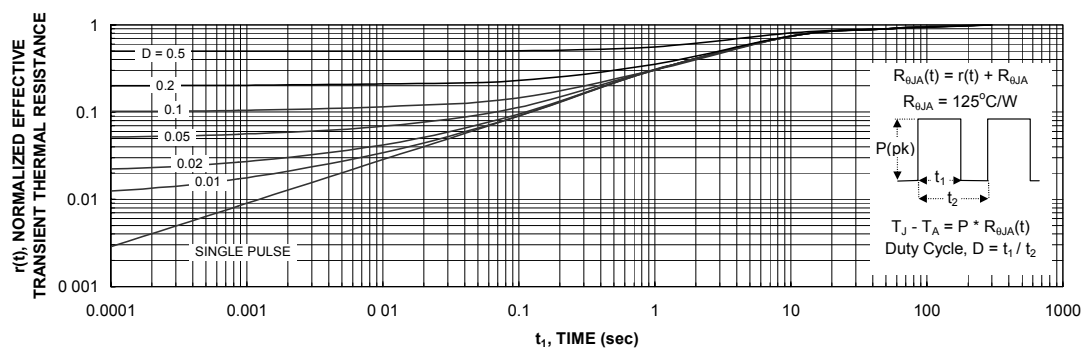


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c.
Transient thermal response will change depending on the circuit board design.

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